

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Vitali Nesterenko et al.)
Serial No.:	10/531,553)
Conf. No.:	3552)
Filed:	May 2, 2006)
For:	ISOSTATIC PRESSURE ASSISTED WAFER BONDING METHOD)
Art Unit:	2823)
Examiner:	Stark, Jarrett J.)

RESPONSE D

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Final Office Action mailed March 5, 2009, and the Advisory Action mailed May 14, 2009, please consider the following remarks: